

Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.



REMINDERS

Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, data-processing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment ^{*1}
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices ^{*2}

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

*Notes:

1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.

TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

► This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (<http://www.ty-top.com/>).

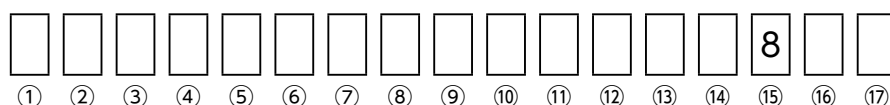
Industrial Application Guide

The products described as “For Telecommunications Infrastructure and Industrial Equipment” in this catalog are intended for use in the equipment shown in the below table as its typical example. Therefore, when using our products for these equipment, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding products. Should you have any questions on this matter, please contact us.

Category	Telecommunications Infrastructure and Industrial Equipment (Typical Example)
Telecommunications Infrastructure	<ul style="list-style-type: none"> • Base Station • Optical Transceiver • Router/Switch (Carrier-Grade) • UPS (Uninterruptible Power Supply), etc.
Factory Automation	<ul style="list-style-type: none"> • PLC (Programmable Logic Controller) • Servomotor/Servo Driver • Industry Robot, etc.
Measurement	<ul style="list-style-type: none"> • Gas Meter • Water Meter • Flow Meter • Pressure Gauge Meter • Magnetometer • Thermometer, etc.
Electric Power Apparatus	<ul style="list-style-type: none"> • Power Conditioner (Solar Power System) • Smart Meter • GFCI (Ground Fault Circuit Interrupter) • Electric Vehicle Charging Station, etc.

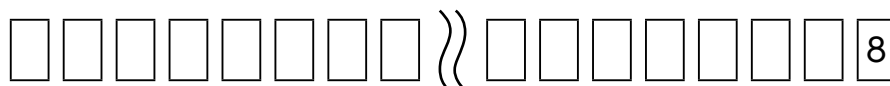
Part Numbering System

Multilayer Ceramic Capacitors:



If the 15th code from the left is “8”, it indicates “For Telecommunications Infrastructure and Industrial Equipment” or “For Medical Devices”.

Inductors:




If the 1st code from the right is “8” regardless of the total digit number, it indicates “For Telecommunications Infrastructure and Industrial Equipment” or “For Medical Devices”.

Because there are some exceptions, for details please refer to each page of this catalog where the part numbering system of each product is described.

Medical Application Guide

The products described as “For Medical Devices” in this catalog are intended for use in the medical devices classified as GHTF Classes A to C (Japan Classes I to III) except for all medical devices classified as GHTF Class D (Japan Class IV) and implantable medical devices (bone-anchored hearing aid, artificial retina system, and external unit which is connected to internal unit which is implanted in a body, etc.). Therefore, when using our products for these medical devices, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding products. Should you have any questions on this matter, please contact us.

Risk Level		Low  High			
Japan	Classification according to the PMD Act of Japan (based on the GHTF Rules)	Class I General Medical Devices (GHTF Class A)	Class II Controlled Medical Devices (GHTF Class B)	Class III Specially-controlled Medical Devices (GHTF Class C)	Class IV Specially-controlled Medical Devices (GHTF Class D)
		Medical devices with extremely low risk to the human body in case of problems [Ex.] • In Vitro Diagnostic Devices • Nebulizer • Blood Gas Analyzer • Plethysmographs • Breathing Sensor • AC-powered Operating Table • Surgical Light • Cholesterol Analysis Device • Blood Type Analysis Device, etc.	Medical devices with relatively low risk to the human body in case of problems [Ex.] • Electronic Thermometer • Electronic Blood Pressure Gauge • Electronic Endoscope • Hearing Aid • Electrocardiograph • MRI • Ultrasonic Diagnostic System • Diagnostic Imaging Equipment • X-ray Diagnostic Equipment • Central Monitor • Pulse Oximeter, etc.	Medical devices with relatively high risk to the human body in case of problems [Ex.] • Dialysis Machine • Radiation Therapy Equipment • Infusion Pump • Respirator • Glucose Monitoring System • AED (Automated External Defibrillator) • Skin Laser Scanner • Electric Surgical Unit • Insulin Pump, etc.	Medical devices highly invasive to patients and with life-threatening risk in case of problems [Ex.] • Cardiac Pacemaker • Video Flexible Angioscope • Implantable Infusion Pump • Cardiac Electrosurgical Unit • Inspection Device with Cardiac Catheter • Defibrillator, etc.
U.S.A.	FDA Classification	Class I General Controls	Class II General Controls and Special Controls	Class III General Controls and Premarket Approval	
		Medical devices without the possibility of causing serious injury or harm to the patient or user even if there is a defect or malfunction in such medical devices	Medical devices with the possibility of causing injury or harm to the patient or user if there is a defect or malfunction in such medical devices	Medical devices with the possibility of causing serious injury, disability or death to the patient or user if a defect or malfunction occurs in such medical devices	

Coverage of those Classes by TAIYO YUDEN Products	Product Series for Medical Devices	
	*Note: It is prohibited that our products are used in some medical devices such as implantable medical devices even if such medical devices are classified as GHTF Class C (Japan Class III).	N/A

WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

REFLOW

PART NUMBER

*Operating Temp. : -40~105°C (Including self-generated heat)

L	B	M	△	2	0	1	6	T	1	0	0	J	△	8
①				②				③				⑤	⑥	⑦

△=Blank space

①Series name

Code	Series name
LBM△	Wound chip inductor for signal line

②Dimensions (L × W)

Code	Type (inch)	Dimensions (L × W) [mm]
2016	2016 (0806)	2.0 × 1.6

③Packaging

Code	Packaging
T	Taping

④Nominal inductance

Code (example)	Nominal inductance [μH]
R12	0.12
1R0	1.00
100	10
101	100

※R=Decimal point

⑤Inductance tolerance

Code	Inductance tolerance
J	±5%

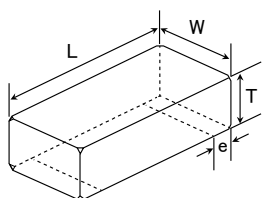
⑥Special code

Code	Special code
△	Standard

⑦Internal code

Code	Internal code
8	Inductor for Telecommunications infrastructure and Industrial equipment / Medical devices

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



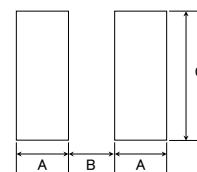
Recommended Land Patterns

Surface Mounting

- Mounting and soldering conditions should be checked beforehand.
- Applicable soldering process to these products is reflow soldering only.

Type	A	B	C
LBM 2016	0.6	1.0	1.8

Unit: mm



Type	L	W	T	e	Standard quantity [pcs]	
					Paper tape	Embossed tape
LBM 2016	2.0±0.2 (0.08±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.02±0.008)	—	2000

Unit: mm (inch)

PART NUMBER

• All the Wire-wound Chip Inductors of the catalog lineup are RoHS compliant.

Notes)

- The exchange of individual specifications is necessary depending on your application and/or circuit condition. Please contact TAIYO YUDEN's official sales channel.
- The products are for Telecommunications infrastructure and Industrial equipment and for Medical devices.
Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications, etc.,
and please review and approve the product specifications before ordering.
Please be sure to contact us for further information in advance when the products are used for automotive electronic equipment.

● LBM2016 type

Part number	Nominal inductance [μH]	Inductance tolerance	Q (min.)	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Note
LBM 2016TR12J 8	0.12	±5%	30	600	0.13	610	25.2	
LBM 2016TR15J 8	0.15	±5%	30	550	0.15	570	25.2	
LBM 2016TR18J 8	0.18	±5%	30	500	0.15	560	25.2	
LBM 2016TR22J 8	0.22	±5%	30	450	0.20	520	25.2	
LBM 2016TR27J 8	0.27	±5%	30	425	0.21	510	25.2	
LBM 2016TR33J 8	0.33	±5%	30	400	0.21	490	25.2	
LBM 2016TR39J 8	0.39	±5%	30	375	0.26	440	25.2	
LBM 2016TR47J 8	0.47	±5%	30	350	0.26	430	25.2	
LBM 2016TR56J 8	0.56	±5%	30	300	0.29	410	25.2	
LBM 2016TR68J 8	0.68	±5%	30	270	0.32	400	25.2	
LBM 2016TR82J 8	0.82	±5%	30	250	0.34	390	25.2	
LBM 2016TR10J 8	1.0	±5%	30	220	0.38	385	7.96	
LBM 2016TR12J 8	1.2	±5%	30	180	0.41	370	7.96	
LBM 2016TR15J 8	1.5	±5%	30	135	0.47	350	7.96	
LBM 2016TR18J 8	1.8	±5%	30	100	0.48	345	7.96	
LBM 2016TR22J 8	2.2	±5%	30	75	0.54	340	7.96	
LBM 2016TR27J 8	2.7	±5%	30	55	0.59	310	7.96	
LBM 2016TR33J 8	3.3	±5%	30	48	0.68	290	7.96	
LBM 2016TR39J 8	3.9	±5%	30	43	0.74	275	7.96	
LBM 2016TR47J 8	4.7	±5%	30	40	0.78	270	7.96	
LBM 2016TR56J 8	5.6	±5%	25	36	0.88	255	7.96	
LBM 2016TR68J 8	6.8	±5%	25	33	0.97	240	7.96	
LBM 2016TR82J 8	8.2	±5%	25	30	1.1	225	7.96	
LBM 2016T100J 8	10	±5%	25	27	1.2	215	2.52	
LBM 2016T120J 8	12	±5%	25	23	1.4	200	2.52	
LBM 2016T150J 8	15	±5%	25	20	1.5	190	2.52	
LBM 2016T180J 8	18	±5%	25	18	2.5	150	2.52	
LBM 2016T220J 8	22	±5%	25	17	2.8	140	2.52	
LBM 2016T270J 8	27	±5%	25	16	3.2	130	2.52	
LBM 2016T330J 8	33	±5%	25	15	3.6	125	2.52	
LBM 2016T390J 8	39	±5%	20	14	3.9	120	2.52	
LBM 2016T470J 8	47	±5%	20	13	4.1	115	2.52	
LBM 2016T560J 8	56	±5%	20	12	5.9	95	2.52	
LBM 2016T680J 8	68	±5%	20	11	7.0	90	2.52	
LBM 2016T820J 8	82	±5%	20	10	7.7	85	2.52	
LBM 2016T101J 8	100	±5%	15	9.0	8.0	80	0.796	

• LBMseries

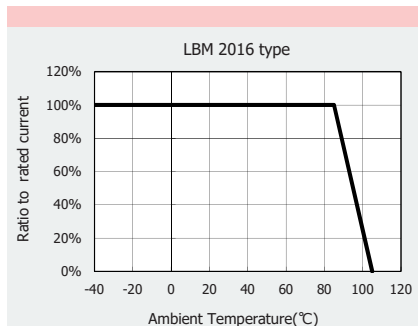
※) Rated Current: The maximum DC value having inductance decrease within 10 % and temperature increase within 20 degC by the application of DC bias.

■ Derating of Rated Current

● LB series M type

Derating of current is necessary for LB series M type depending on ambient temperature.

Please refer to the chart shown below for appropriate derating of current.



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WIRE-WOUND CHIP INDUCTORS (LB SERIES),
WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES),
WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

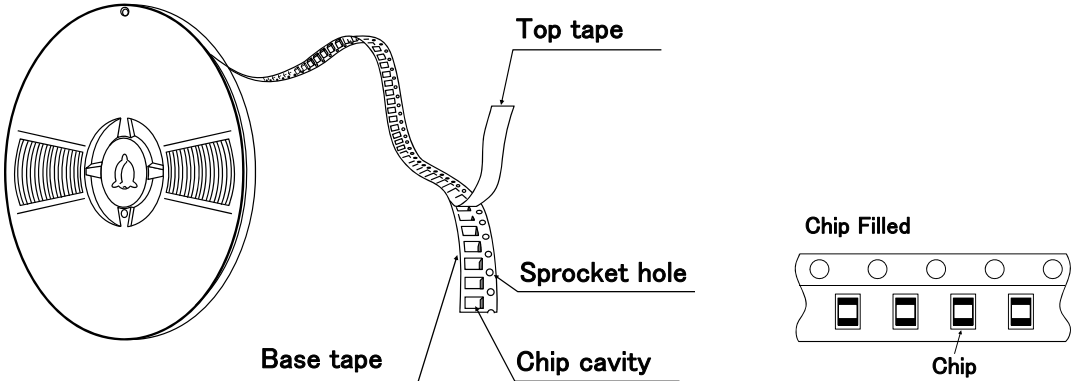
PACKAGING

① Minimum Quantity

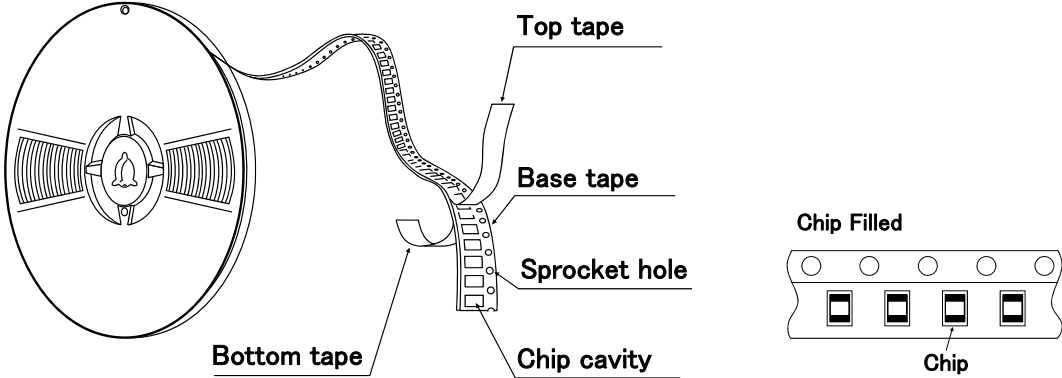
Type	Standard Quantity [pcs]	
	Paper Tape	Embossed Tape
LB C3225	—	1000
CB C3225	—	1000
LB 3218	—	2000
LB R2518	—	2000
LB C2518	—	2000
LB 2518	—	2000
CB 2518	—	2000
CB C2518	—	2000
LBM2016	—	2000
LB C2016	—	2000
LB 2016	—	2000
CB 2016	—	2000
CB C2016	—	2000
LB 2012	—	3000
LB C2012	—	3000
LB R2012	—	3000
CB 2012	—	3000
CB C2012	—	3000
CB L2012	4000	—
LB 1608	4000	—
LBMF1608	—	3000
CBMF1608	—	3000

② Tape material

Embossed tape



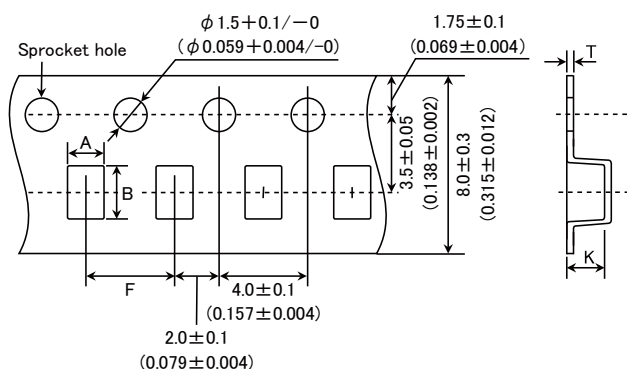
Card board carrier tape



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For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>) .

③Taping Dimensions

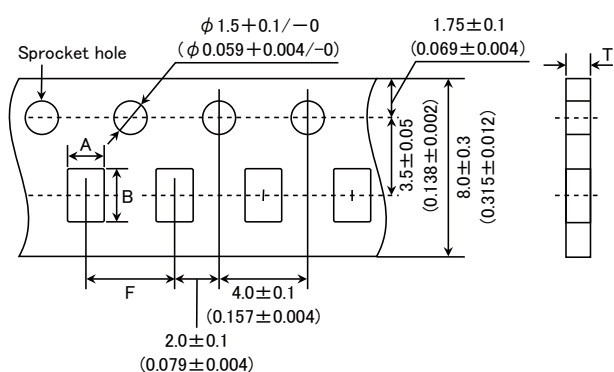
● Embossed Tape (0.315 inches wide)



Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
LBM2016	1.75 ± 0.1 (0.069 ± 0.004)	2.1 ± 0.1 (0.083 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 ± 0.05 (0.012 ± 0.002)	1.9max. (0.075max.)
LB C3225 CB C3225	2.8 ± 0.1 (0.110 ± 0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 ± 0.05 (0.012 ± 0.002)	4.0max. (0.157max.)
LB 3218	2.1 ± 0.1 (0.083 ± 0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 ± 0.05 (0.012 ± 0.002)	2.2max. (0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15 ± 0.1 (0.085 ± 0.004)	2.7 ± 0.1 (0.106 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 ± 0.05 (0.012 ± 0.002)	2.2max. (0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75 ± 0.1 (0.069 ± 0.004)	2.1 ± 0.1 (0.083 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.3 ± 0.05 (0.012 ± 0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45 ± 0.1 (0.057 ± 0.004)	2.25 ± 0.1 (0.089 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.25 ± 0.05 (0.010 ± 0.002)	1.45max. (0.057max.)
LBMF1608 CBMF1608	1.1 ± 0.1 (0.043 ± 0.004)	1.9 ± 0.1 (0.075 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	0.25 ± 0.05 (0.010 ± 0.002)	1.2max. (0.047max.)

Unit : mm (inch)

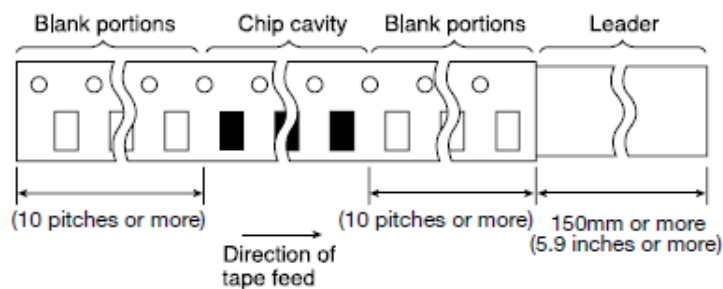
● Card board carrier tape (0.315 inches wide)



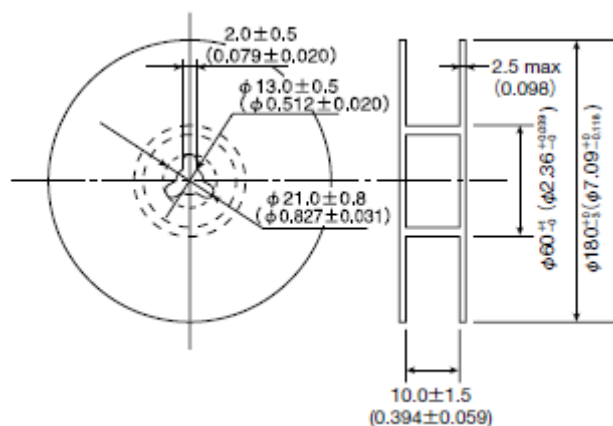
Type	Chip cavity		Insertion pitch	Tape thickness
	A	B	F	T
CB L2012	1.55 ± 0.1 (0.061 ± 0.004)	2.3 ± 0.1 (0.091 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	1.1max. (0.043max.)
LB 1608	1.0 ± 0.1 (0.039 ± 0.004)	1.8 ± 0.1 (0.071 ± 0.004)	4.0 ± 0.1 (0.157 ± 0.004)	1.1max. (0.043max.)

Unit : mm (inch)

④ Leader and Blank Portion

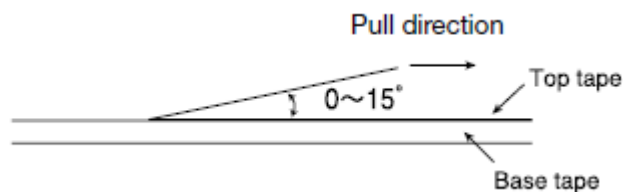


⑤ Reel Size



⑥ Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.

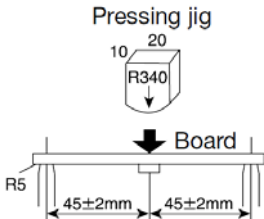


WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

RELIABILITY DATA

1.Operating temperature Range		
Specified Value	LB, LBC, LBR Series	−40∼+105°C (Including self-generated heat)
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Including self-generated heat	
2. Storage Temperature Range (after soldering)		
Specified Value	LB, LBC, LBR Series	−40∼+85°C
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB, CB Series : Please refer the term of “7. storage conditions” in precautions.	
3.Rated Current		
Specified Value	LB, LBC, LBR Series	Within the specified tolerance
	CB, CBC Series	
	LBM Series	
4.Inductance		
Specified Value	LB, LBC, LBR Series	Within the specified tolerance
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB•LBC•LBR•CB•CBC•LBM Series Measuring equipment :LCR Mater (HP4285A or its equivalent)	
5.Q		
Specified Value	LB, LBC, LBR Series	—
	CB, CBC Series	
	LBM Series	Within the specified tolerance
Test Methods and Remarks	LBM Series Measuring equipment : LCR Mater (HP4285A or its equivalent)	
6.DC Resistance		
Specified Value	LB, LBC, LBR Series	Within the specified tolerance
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Measuring equipment : DC Ohmmeter (HIOKI 3227 or its equivalent)	
7.Self-Resonant Frequency		
Specified Value	LB, LBC, LBR Series	Within the specified tolerance
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or its equivalent)	

8.Temperature Characteristic					
Specified Value	LBM2016				Inductance change : Within $\pm 10\%$
	LB2012	LBR2012	CB2012	LB2016	Inductance change : Within $\pm 20\%$
	CB2016	LB2518	LBR2518	CB2518	
	LBC3225	CBC3225			Inductance change : Within $\pm 25\%$
	LBC2016	CBC2016	LBC2518	CBC2518	
Test Methods and Remarks	LB3218				Inductance change : Within $\pm 35\%$
	LBC2012	CBC2012			
	Change of maximum inductance deviation in step 1-5				
	Step	Temperature($^{\circ}\text{C}$)			
		LB, CB Serie			
	1	20			
	2	-40			
	3	20 (Reference temperature)			
	4	+85 (Maximum operating temperature)			
	5	20			

9.Rasistance to Flexure of Substrate		
Specified Value	LB, LBC, LBR Series	No damage.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Warp : 2mm (LB・LBC・LBR・CB・CBC・LBM Series)	
	Test substrate : Board according to JIS C0051	
	Thickness : 1.0mm	
Test Methods and Remarks		

10.Body Strength		
Specified Value	LB, LBC, LBR Series	No damage.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB・LBC・LBR・CB・CBC・LBM Applied force : 10N Duration : 10sec.	

11.Adhesion of terminal electrode		
Specified Value	LB, LBC, LBR Series	No abnormality.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB・LBC・LBR・CB・CBC・CBL・LBM	
	Applied force : 10N to X and Y directions	
	Duration : 5 sec.	
	Test substrate : Printed board	

12.Resistance to vibration		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	Inductance change : Within±20% No significant abnormality in appearance.
Test Methods and Remarks	LB•LBR•LBC•CB•CBC•LBM : According to JIS C5102 clause 8.2. Vibration type : A Directions : 2 hrs each in X, Y and Z directions. Total:6 hrs Frequency range : 10 to 55 to 10 Hz(1min.) Amplitude : 1.5mm Mounting method : Soldering onto printed board Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

13.Drop test		
Specified Value	LB, LBC, LBR Series	—
	CB, CBC Series	
	LBM Series	

14.Solderability		
Specified Value	LB, LBC, LBR Series	At least 90% of surface of terminal electrode is covered by new
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB•LBC•LBR•CB•CBC•CBL•LBM : Solder temperature : 245±5℃ Duration : 5±0.5sec Flux : Methanol solution with 25% of colophony	

15.Resistance to soldering		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20%
	CB, CBC Series	
	LBM Series	Inductance change : Within±20%
Test Methods and Remarks	LB•LBC•LBR•CB•CBC•CBL•LBM : 3 times of reflow oven at 230℃ MIN for 40sec. with peak temperature at 260 ℃ for 5sec.	

16.Resisittance to solvent		
Specified Value	LB, LBC, LBR Series	—
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Solvent temperature : Room temperature Type of solvent : Isopropyl alcohol Cleaning conditions : 90s. Immersion and cleaning.	

17.Thermal shock		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	LB•LBC•LBR•CB•CBC•CBL•LBM : −40∼+85℃, maintain times 30min. ,100 cycle Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

18.Damp heat life test		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Temperature : 60±2℃ Humidity : 90~95%RH Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	
19.Loading under damp heat life test		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Temperature : 60±2℃ Humidity : 90~95%RH Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	
20.High temperature life test		
Specified Value	LB, LBC, LBR Series	—
	CB, CBC Series	Inductance change : Within±20% No significant abnormality in appearance.
	LBM Series	
Test Methods and Remarks	Temperature : 85±2℃ Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	
21.Loading at high temperature life test		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	—
Test Methods and Remarks	Temperature : 85±2℃ Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	
22.Low temperature life test		
Specified Value	LB, LBC, LBR Series	Inductance change : Within±20% No significant abnormality in appearance.
	CB, CBC Series	
	LBM Series	
Test Methods and Remarks	Temperature : —40±2℃ Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	
23.Standard condition		
Specified Value	LB, LBC, LBR Series	Standard test conditions Unless specified, Ambient temperature is 20±15℃ and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2℃ Relative humidity: 65±5% Inductance value is based on our standard measurement systems.
	CB, CBC Series	
	LBM Series	

WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

■ PRECAUTIONS

1. Circuit Design

Precautions	<p>◆Operating environment</p> <p>1. The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive interior applications, etc.</p> <p>Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment).</p> <p>Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).</p>
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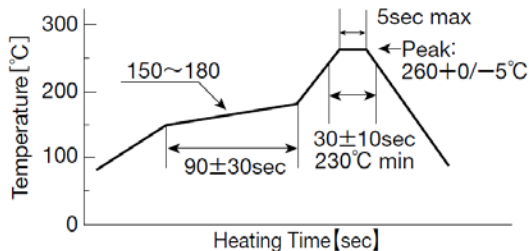
2. PCB Design

Precautions	<p>◆Land pattern design</p> <p>1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.</p>
Technical considerations	<p>PRECAUTIONS</p> <p>【Recommended Land Patterns】</p> <p>Surface Mounting</p> <ul style="list-style-type: none"> • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to those products is reflow soldering only.

3. Considerations for automatic placement

Precautions	<p>◆Adjustment of mounting machine</p> <p>1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.</p> <p>2. Mounting and soldering conditions should be checked beforehand.</p>
Technical considerations	<p>1. When installing products, care should be taken not to apply distortion stress as it may deform the products.</p>

4. Soldering

Precautions	<p>◆Reflow soldering(LB and CB Types)</p> <p>1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended.</p> <p>◆Recommended conditions for using a soldering iron</p> <p>1. Put the soldering iron on the land-pattern. Soldering iron's temperature – Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.</p>
Technical considerations	<p>◆Reflow soldering(LB and CB Types)</p> <p>1. Reflow profile</p>  <p>Temperature [°C]</p> <p>Heating Time [sec]</p> <p>◆Recommended conditions for using a soldering iron</p> <p>1. Components can be damaged by excessive heat where soldering conditions exceed the specified range.</p>

5. Cleaning

Precautions	<p>◆Cleaning conditions</p> <p>Washing by supersonic waves shall be avoided.</p>
Technical considerations	<p>◆Cleaning conditions</p> <p>If washed by supersonic waves, the products might be broken.</p>

6. Handling	
Precautions	<ul style="list-style-type: none"> ◆Handling <ol style="list-style-type: none"> 1. Keep the inductors away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations <ol style="list-style-type: none"> 1. Please do not give the inductors any excessive mechanical shocks.
Technical considerations	<ul style="list-style-type: none"> ◆Handling <ol style="list-style-type: none"> 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. ◆Mechanical considerations <ol style="list-style-type: none"> 1. There is a case to be damaged by a mechanical shock.
7. Storage conditions	
Precautions	<ul style="list-style-type: none"> ◆Storage <ol style="list-style-type: none"> 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> ▪ Recommended conditions Ambient temperature: 0~40°C / Humidity: Below 70% RH <p>The ambient temperature must be kept below 30°C even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, These series should be used within 6 months from the time of delivery.</p>
Technical considerations	<ul style="list-style-type: none"> ◆Storage <ol style="list-style-type: none"> 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.